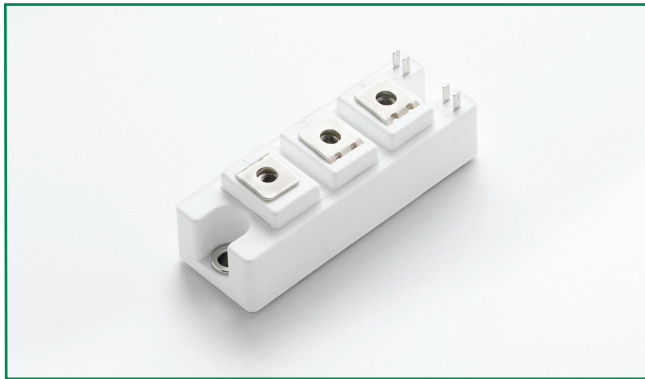


MG06100S-BR1MM




Features

- Ultra Low Loss
- High Ruggedness
- High Short Circuit Capability
- Positive Temperature Coefficient
- With Fast Free-Wheeling Diodes

Applications

- Inverter
- Converter
- Welder
- SMPS and UPS
- Induction Heating

Agency Approvals

AGENCY	AGENCY FILE NUMBER
	E71639

Module Characteristics ($T_c = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Typ	Max	Unit
R_{thJC}	Junction-to-Case Thermal Resistance	Per IGBT			0.2	K/W
R_{thJD}		Per Inverse Diode			0.5	K/W
Torque	Module-to-Sink	Recommended (M6)	3		5	N-m
Torque	Module Electrodes	Recommended (M5)	2.5		5	N-m
Weight				150		g

Absolute Maximum Ratings ($T_c = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameters	Test Conditions	Values	Unit
IGBT				
V_{CES}	Collector - Emitter Voltage		600	V
V_{GES}	Gate - Emitter Voltage		± 20	V
I_c	DC Collector Current	$T_c=25^\circ\text{C}$	150	A
		$T_c=80^\circ\text{C}$	105	A
I_{cpuls}	Pulsed Collector Current	$T_c=25^\circ\text{C}, t_p=1\text{ms}$	300	A
		$T_c=80^\circ\text{C}, t_p=1\text{ms}$	210	
P_{tot}	Power Dissipation Per IGBT		625	W
T_J	Junction Temperature Range		-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^\circ\text{C}$
V_{isol}	Insulation Test Voltage	AC, $t=1\text{min}$	3000	V
Diode				
V_{RRM}	Repetitive Reverse Voltage		600	V
$I_{F(AV)}$	Average Forward Current	$T_c=25^\circ\text{C}$	125	A
		$T_c=80^\circ\text{C}$	85	A
$I_{F(RMS)}$	RMS Forward Current		122	A
I_{FSM}	Non-Repetitive Surge Forward Current	$T_J=45^\circ\text{C}, t=10\text{ms}$, Sine	500	A
		$T_J=45^\circ\text{C}, t=8.3\text{ms}$, Sine	545	

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

MG06100S-BR1MM

Electrical and Thermal Specifications ($T_c = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Typ	Max	Unit
IGBT						
$V_{GE(th)}$	Gate - Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=250\mu\text{A}$	3.5		5.5	V
$V_{CE(sat)}$	Collector - Emitter Saturation Voltage	$I_C=100\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.9		V
		$I_C=100\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2.1		V
I_{CES}	Collector Leakage Current	$V_{CE}=600\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			0.5	mA
		$V_{CE}=600\text{V}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		3		mA
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}$	-1.1		1.1	μA
Q_{ge}	Gate Charge	$V_{CC}=300\text{V}, I_C=100\text{A}, V_{GE}=\pm 15\text{V}$		230		nC
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		5.3		nF
C_{oes}	Output Capacitance			0.52		
C_{res}	Reverse Transfer Capacitance			0.34		
$t_{d(on)}$	Turn - on Delay Time	$V_{CC}=300\text{V}$ $I_C=100\text{A}$ $R_G=10\Omega$ $V_{GE}=\pm 15\text{V}$ Inductive Load	$T_J=25^\circ\text{C}$		45	ns
			$T_J=125^\circ\text{C}$		50	ns
t_r	Rise Time		$T_J=25^\circ\text{C}$		45	ns
			$T_J=125^\circ\text{C}$		45	ns
$t_{d(off)}$	Turn - off Delay Time		$T_J=25^\circ\text{C}$		320	ns
			$T_J=125^\circ\text{C}$		350	ns
t_f	Fall Time		$T_J=25^\circ\text{C}$		35	ns
			$T_J=125^\circ\text{C}$		40	ns
E_{on}	Turn - on Energy		$T_J=25^\circ\text{C}$		3.5	mJ
			$T_J=125^\circ\text{C}$		4.5	mJ
E_{off}	Turn - off Energy	$T_J=25^\circ\text{C}$		2.5	mJ	
		$T_J=125^\circ\text{C}$		3.5	mJ	
Diode						
V_F	Forward Voltage	$I_F=100\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.9	2.2	V
		$I_F=100\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.7	2.0	V
t_{rr}	Reverse Recovery Time	$I_F=100\text{A}, V_R=400\text{V}$ $di_P/dt=-1000\text{A}/\mu\text{s}$ $T_J=125^\circ\text{C}$		50		ns
I_{RRM}	Max. Reverse Recovery Current			45		A
Q_{rr}	Reverse Recovery Charge			1.5		μC

Figure 1: Typical Output Characteristics

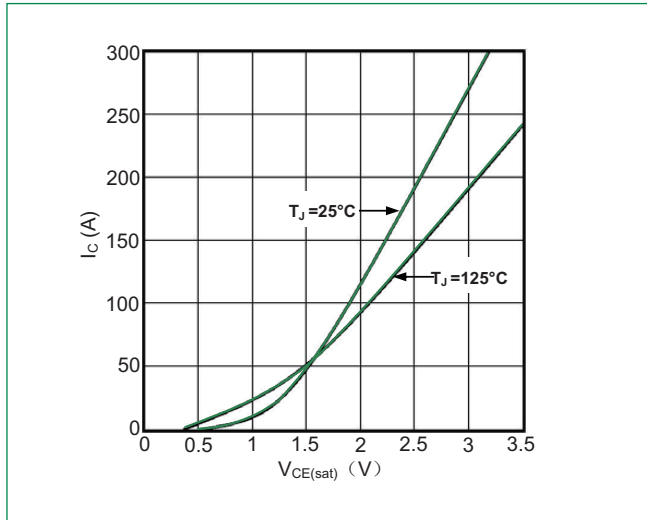


Figure 2: Typical Transfer characteristics

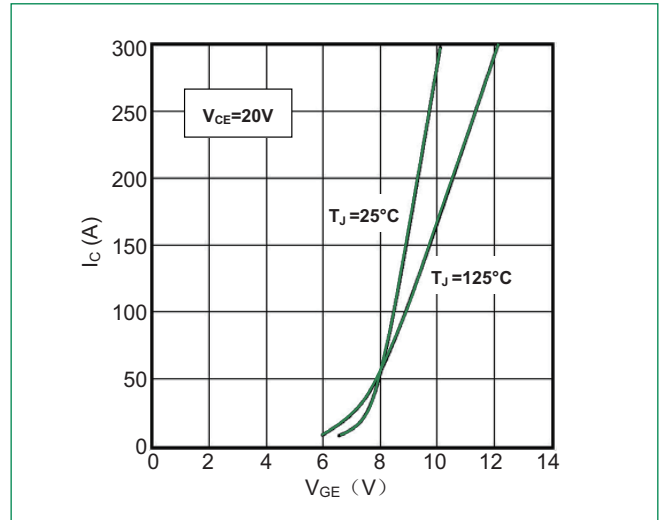


Figure 3: Switching Energy vs. Collector Current

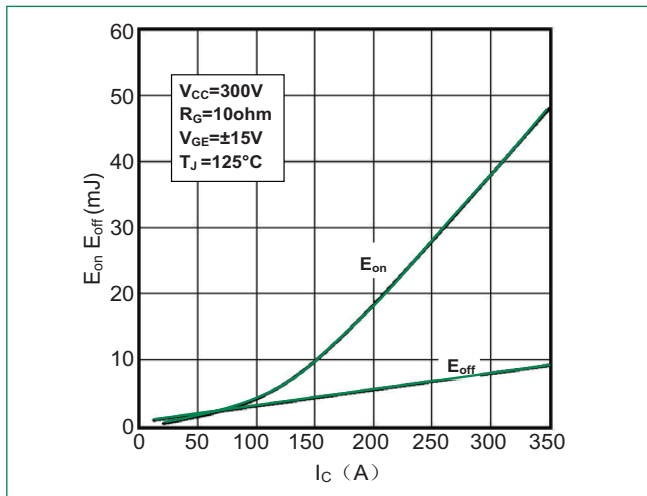


Figure 4: Switching Energy vs. Gate Resistor

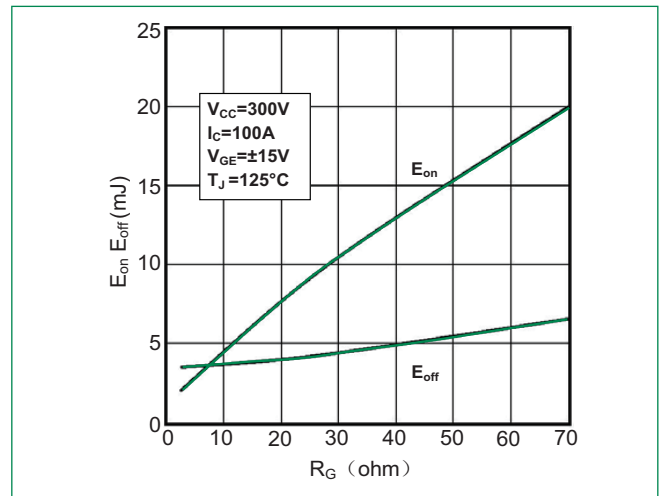


Figure 5: Switching Times vs. Collector Current

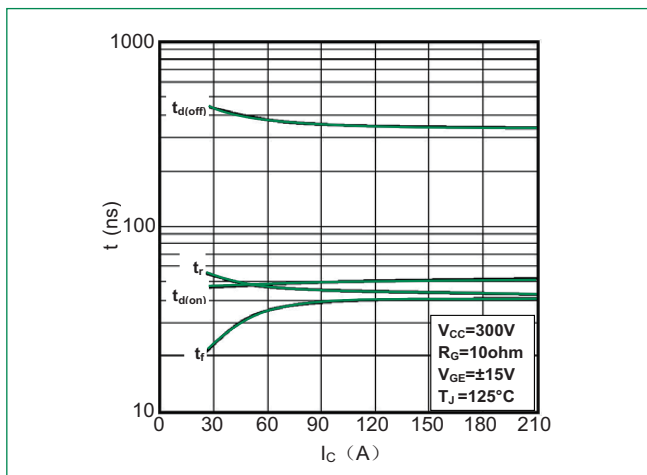


Figure 6: Switching Times vs. Gate Resistor

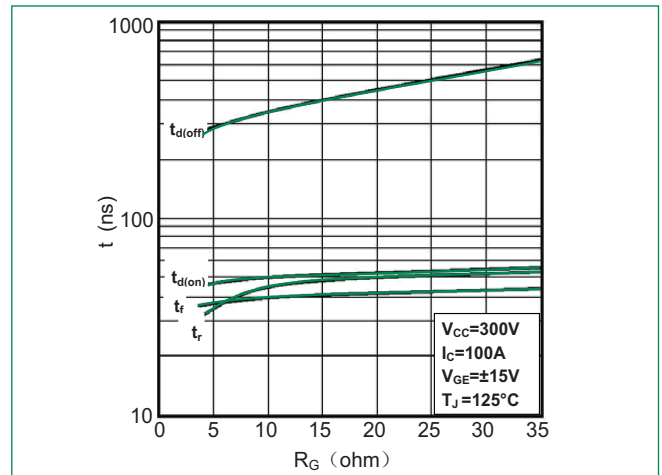


Figure 7: Gate Charge characteristics

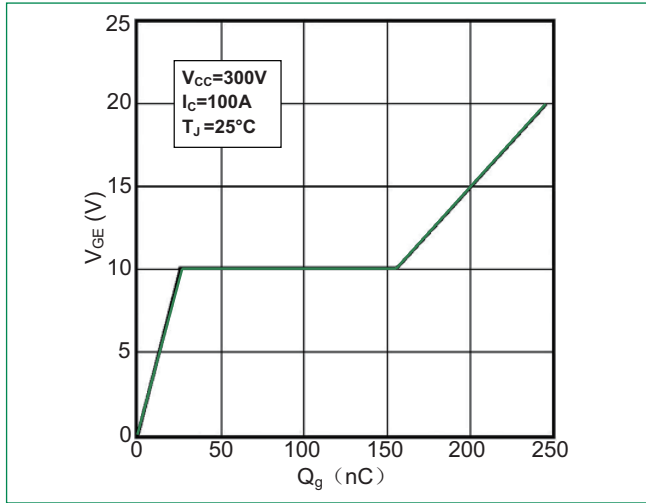


Figure 8: Typical Capacitances vs. V_{CE}

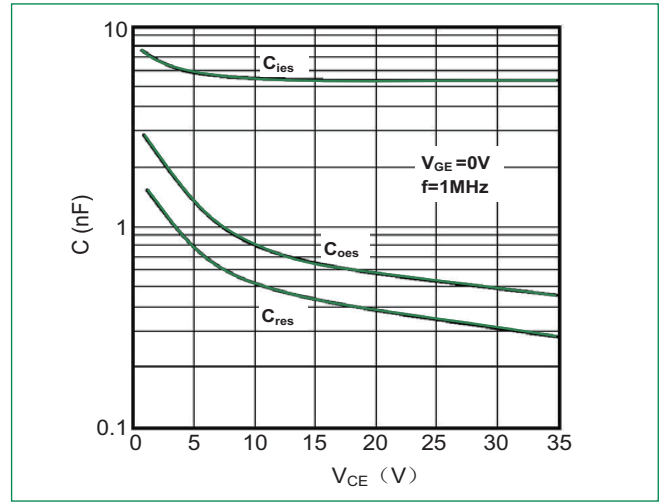


Figure 9: Reverse Biased Safe Operating Area

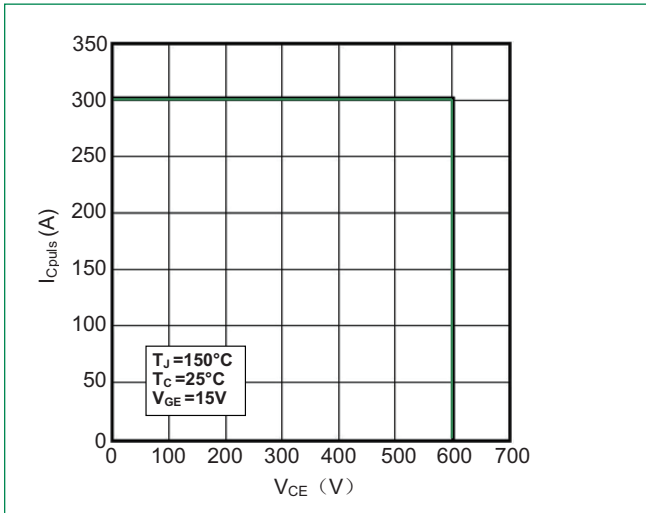


Figure 10: Short Circuit Safe Operating Area

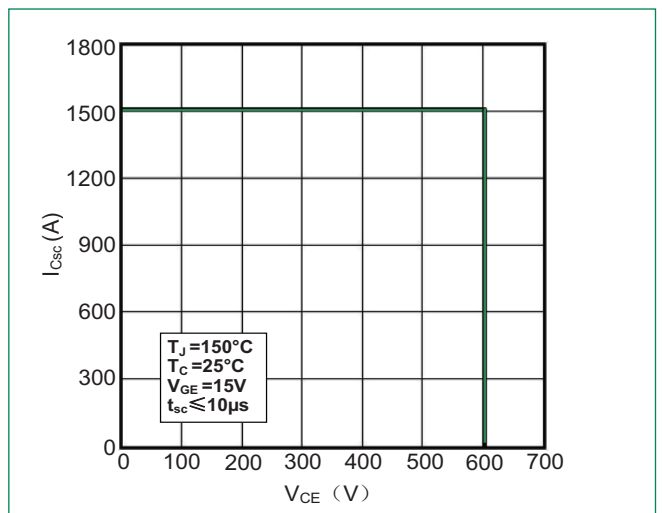


Figure 11: Rated Current vs. T_c

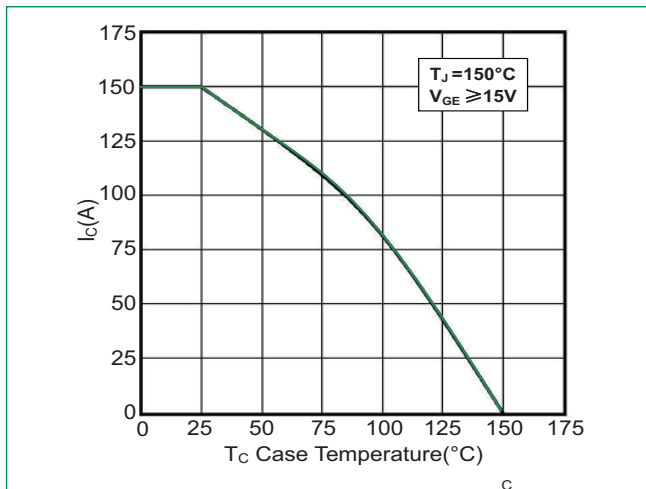


Figure 12: Diode Forward Characteristics

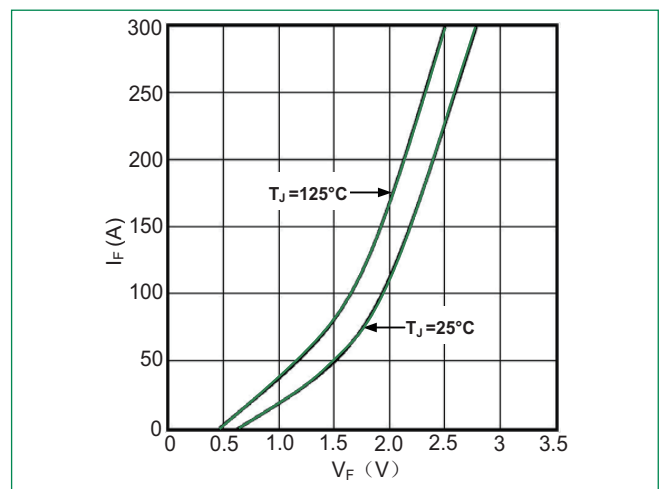


Figure 13: Transient Thermal Impedance of IGBT

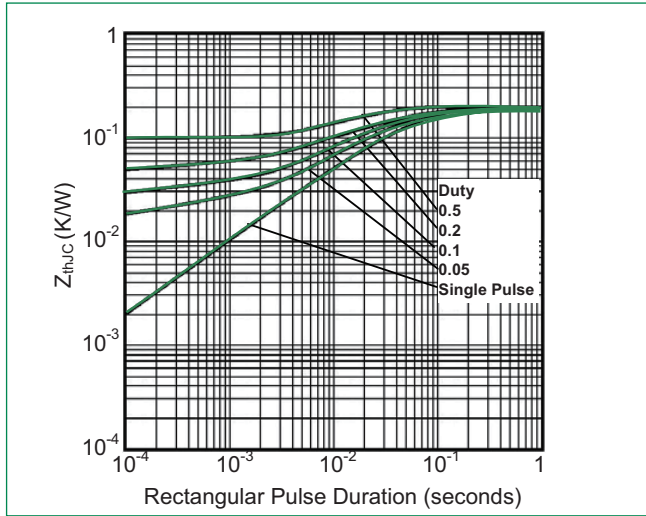
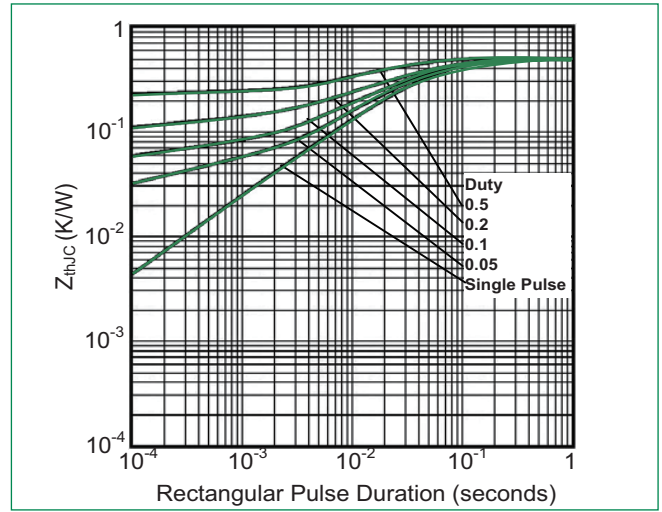
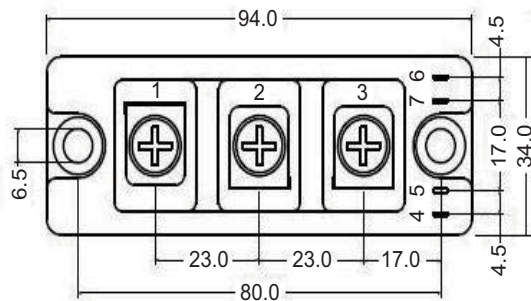
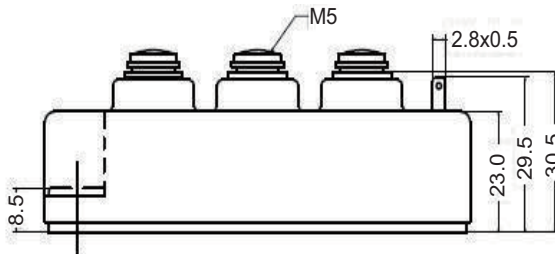


Figure 14: Transient Thermal Impedance of Diode

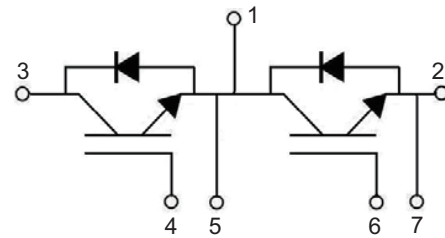


Dimensions-Package S



Dimensions in mm

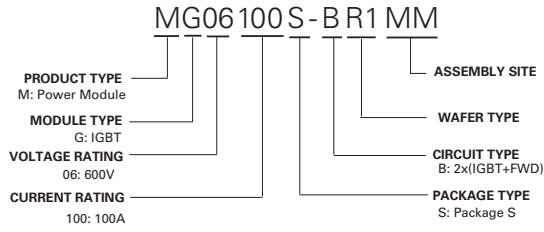
Circuit Diagram



Packing Options

Part Number	Marking	Weight	Packing Mode	M.O.Q
MG06100S-BR1MM	MG06100S-BR1MM	150g	Bulk Pack	100

Part Numbering System



Part Marking System

